

V <sub>DSS</sub>	-12V
R <sub>DS(on)</sub> (Max.)	260mΩ
Ι <sub>D</sub>	±1.3A
P <sub>D</sub>	1.0W

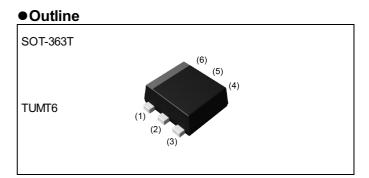
### Features

- 1) Low on resistance.
- 2) -1.5V Drive.

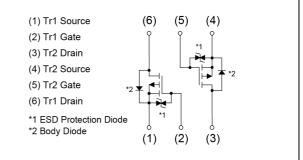
Application

Switching

- 3) Built-in G-S Protection Diode.
- 4) Small Surface Mount Package (TUMT6).
- 5) Pb-free lead plating ; RoHS compliant



#### Inner circuit



## Packaging specifications

Packing	Embossed Tape
Reel size (mm)	180
Tape width (mm)	8
Basic ordering unit (pcs)	3000
Taping code	TR
Marking	J11
	Reel size (mm) Tape width (mm) Basic ordering unit (pcs) Taping code

## • Absolute maximum ratings ( $T_a = 25^{\circ}C$ ,unless otherwise specified) <Tr1 and Tr2>

U (u	. ,			
Parameter		Symbol	Value	Unit
Drain - Source voltage		V <sub>DSS</sub>	-12	V
Continuous drain current		I <sub>D</sub>	±1.3	А
Pulsed drain current		I <sub>DP</sub> <sup>*1</sup>	±5.2	А
Gate - Source voltage		V <sub>GSS</sub>	±10	V
total		D *2	1.0	
Power dissipation	element	P <sub>D</sub> *2	0.7	W
total		P <sub>D</sub> *3	0.91	
Junction temperature		Tj	150	°C
Operating junction and storage temperature range		T <sub>stg</sub>	-55 to +150	°C

#### •Thermal resistance

Parameter		Sumbol	Values			Linit
		Symbol	Min.	Тур.	Max.	Unit
	total	D *2	-	-	125	
Thermal resistance, junction - ambient	element	$R_{thJA}^{*2}$	-	-	179	°C/W
	total	$R_{thJA}^{*3}$	-	-	137	

## • Electrical characteristics ( $T_a = 25^{\circ}C$ ) <Tr1 and Tr2>

Deremeter	Cumphal	Conditions	Values			l lucit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -1mA	-12	-	-	V
Breakdown voltage	$\Delta V_{(BR)DSS}$	I <sub>D</sub> = -1mA	_	-21.9	-	mV/°C
temperature coefficient	$\Delta T_j$	referenced to 25°C		21.5		11107 0
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = -12V, V <sub>GS</sub> = 0V	-	-	-1	μA
Gate - Source leakage current	I <sub>GSS</sub>	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±10V	-	-	±10	μA
Gate threshold voltage	$V_{GS(th)}$	V <sub>DS</sub> = -6V, I <sub>D</sub> = -1mA	-0.3	-	-1.0	V
Gate threshold voltage	$\Delta V_{GS(th)}$	I <sub>D</sub> = -1mA		2.4	-	mV/°C
temperature coefficient	$\Delta T_j$	referenced to 25°C	-	2.4		
		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -1.3A	-	190	260	
		V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -0.6A	-	280	390	
Static drain - source	D *4	V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -0.6A	-	400	600	
on - state resistance	$R_{DS(on)}^{*4}$	V <sub>GS</sub> = -1.5V, I <sub>D</sub> = -0.2A	-	530	1060	mΩ
		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -1.3A T <sub>i</sub> = 125°C	-	280	400	
Gate resistance	R <sub>G</sub>	f = 1MHz, open drain	-	28	-	Ω
Forward Transfer Admittance	Y <sub>fs</sub>  *4	V <sub>DS</sub> = -6V, I <sub>D</sub> = -1.3A	1.4	2.8	-	S



## •Electrical characteristics ( $T_a = 25^{\circ}C$ ) <Tr1 and Tr2>

Deremeter	Sumpleal	Conditions		Unit		
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V	-	290	-	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = -6V	-	28	-	pF
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	-	21	-	
Turn - on delay time	t <sub>d(on)</sub> *4	$V_{DD} \simeq -6V, V_{GS} = -4.5V$	-	8	-	
Rise time	t <sub>r</sub> *4	I <sub>D</sub> = -0.6A	-	10	-	20
Turn - off delay time	t <sub>d(off)</sub> *4	R <sub>L</sub> = 10Ω	-	30	-	ns
Fall time	t <sub>f</sub> *4	R <sub>G</sub> = 10Ω	-	9	-	

## •Gate charge characteristics ( $T_a = 25^{\circ}C$ ) <Tr1 and Tr2>

Deremeter	Symbol	Symbol Conditions		Values		
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Total gate charge	$Q_g^{*4}$	$V_{DD} \simeq -6V$	-	2.4	-	
Gate - Source charge	Q <sub>gs</sub> *4	I <sub>D</sub> = -1.3A	-	0.6	-	nC
Gate - Drain charge	Q <sub>gd</sub> *4	V <sub>GS</sub> = -4.5V	-	0.4	-	

## •Body diode electrical characteristics (Source-Drain) (T<sub>a</sub> = 25°C)

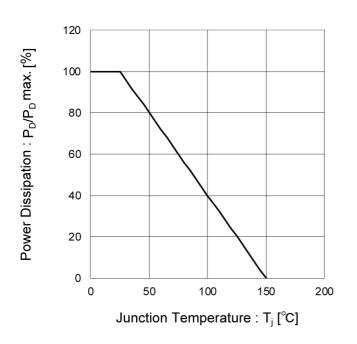
<Tr1 and Tr2>

Parameter	Symbol Conditions			Unit		
	Symbol	Conditions	Min.	Тур.	Max.	Unit
Continuous forward current	I <sub>S</sub>	$T = 25^{\circ}$	-	-	-0.5	^
Pulse forward current	$I_{SP}^{*1}$	T <sub>a</sub> = 25°C	-	-	-5.2	A
Forward voltage	$V_{SD}^{*4}$	V <sub>GS</sub> = 0V, I <sub>S</sub> = -1.3A	-	-	-1.2	V

\*1 Pw $\leq$ 10µs , Duty cycle $\leq$ 1%

- \*2 Mounted on a ceramic board(30×30×0.8mm)
- \*3 Mounted on a FR4 (25×25×0.8mm,Cu pad:625mm<sup>2</sup>)
- \*4 Pulsed





#### Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area

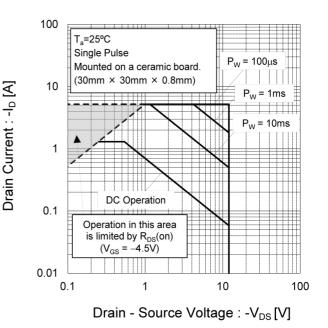
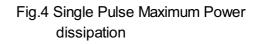
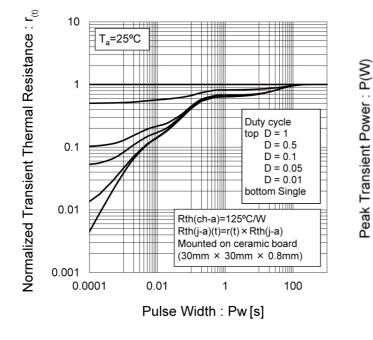
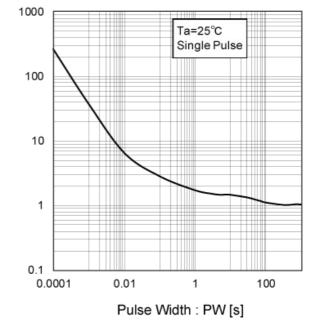


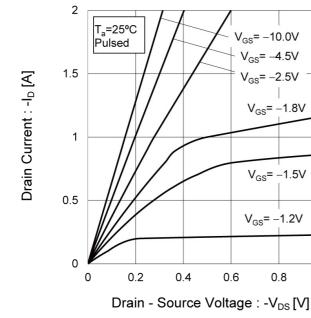
Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width











## Fig.5 Typical Output Characteristics(I)

Fig.6 Typical Output Characteristics(II)

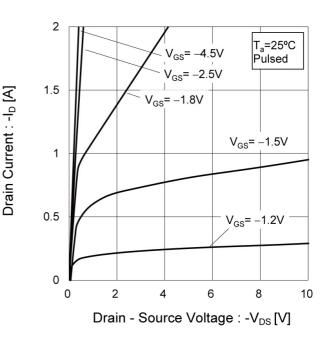
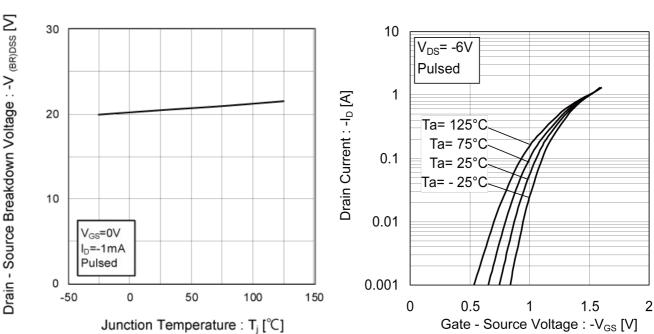


Fig.8 Typical Transfer Characteristics



1

**Junction Temperature** 

Fig.7 Breakdown Voltage vs.





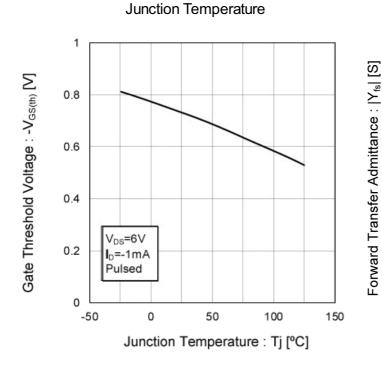


Fig.9 Gate Threshold Voltage vs.

## Fig.10 Forward Transfer Admittance vs. Drain Current

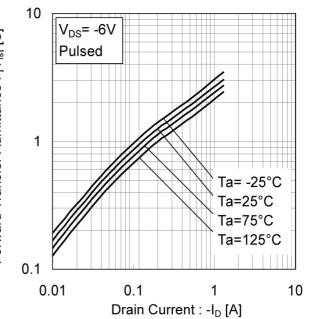
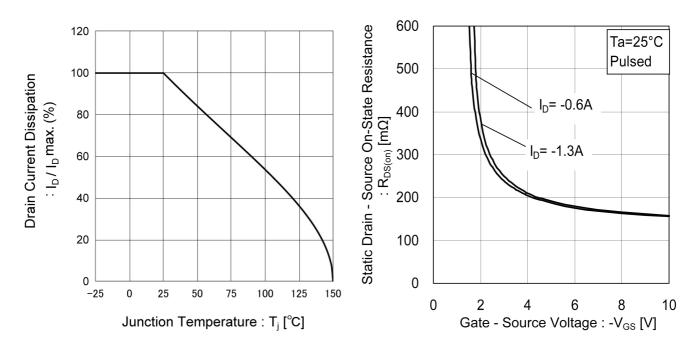


Fig.11 Drain Current Derating Curve

Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage





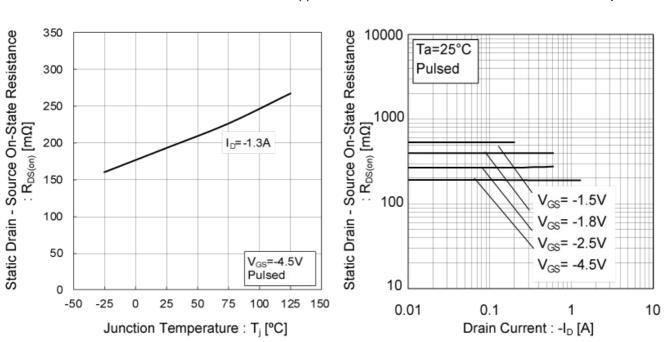


Fig.13 Static Drain - Source On - State Resistance vs. Drain Current (I) Fig.14 Static Drain - Source On - State Resistance vs. Junction Temperature





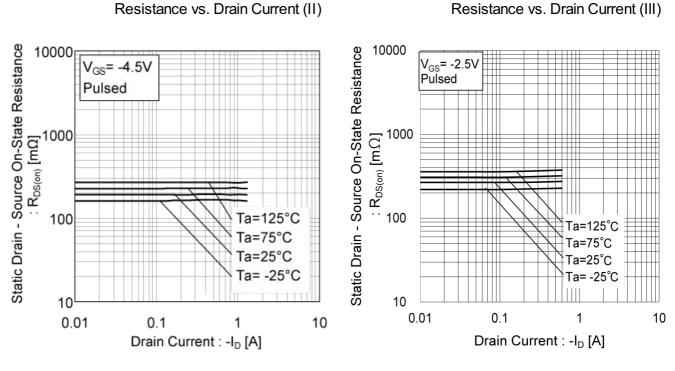


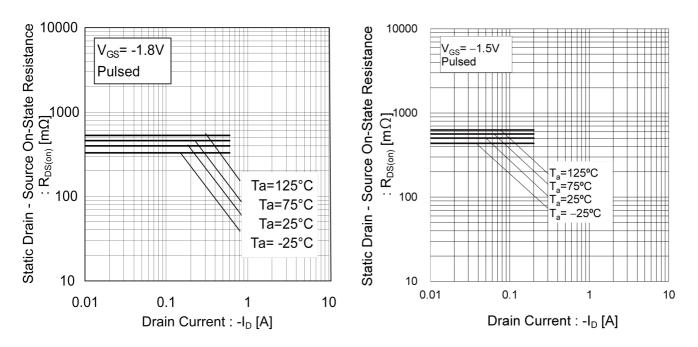
Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II)

Fig.17 Static Drain - Source On - State

Resistance vs. Drain Current (IV)

Fig.18 Static Drain - Source On - State Resistance vs. Drain Current (V)

Fig.16 Static Drain - Source On - State





Ta=25°C V<sub>DD</sub>= -6V

V<sub>GS</sub>= -4.5V

10

 $R_{G}=10\Omega$ 

Pulsed

### • Electrical characteristic curves

Fig.19 Typical Capacitance vs.

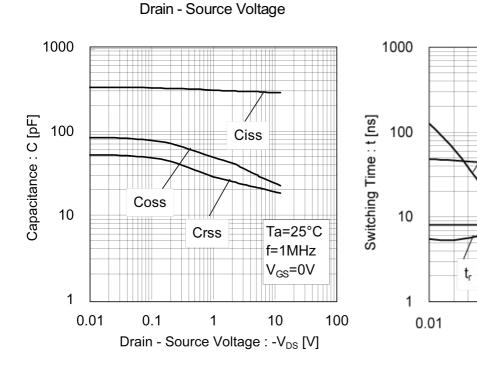


Fig.21 Dynamic Input Characteristics

## Fig.20 Switching Characteristics

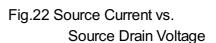
tf

t<sub>d</sub>(off)

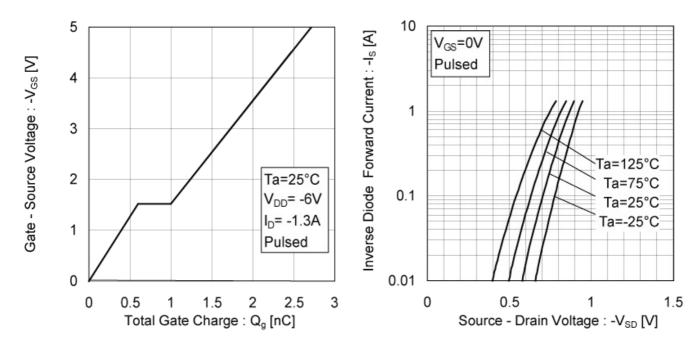
t<sub>d</sub>(on)

Drain Current : -I<sub>D</sub> [A]

1



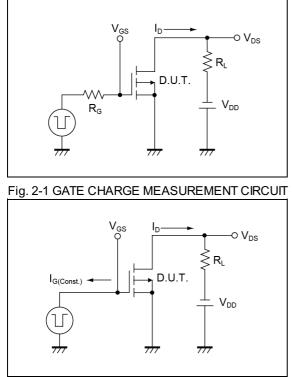
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## •Measurement circuits <It is the same for the Tr1 and Tr2>

#### Fig. 1-1 SWITCHING TIME MEASUREMENT CIRCUIT



#### Fig. 1-2 SWITCHING WAVEFORMS

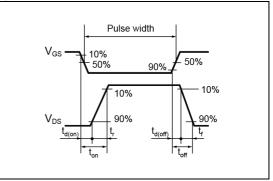
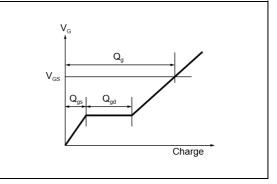


Fig. 2-2 GATE CHARGE WAVEFORM

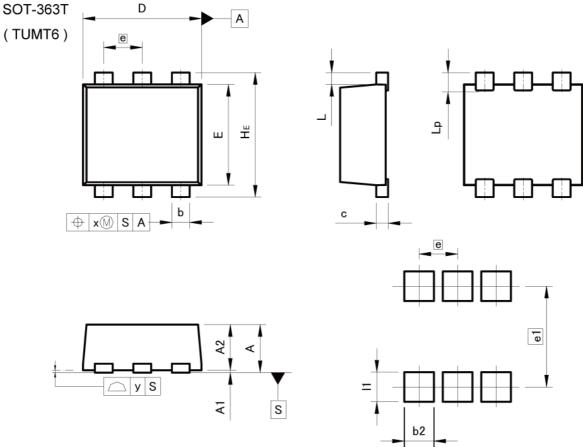


#### Notice

This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.



## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
A	-	0.85	-	0.033	
A1	0.00	0.05	0.000	0.002	
A2	0.72	0.82	0.028	0.032	
b	0.25	0.40	0.010	0.016	
с	0.12	0.22	0.005	0.009	
D	1.90	2.10	0.075	0.083	
E	1.60	1.80	0.063	0.071	
е	0.	65	0.026		
HE	2.00	2.20	0.079	0.087	
L	0.	20	0.008		
Lp		0.40	-	0.016	
x	<u> </u>	0.10	-	0.004	
У	-	0.10	-	0.004	
DIM	MILIMETERS		INC	HES	
DIM	MIN	MAX	MIN	MAX	
b2	-	0.50	-	0.020	
e1	1.	70	0.0	67	
1	- T	0.50		0.020	

Dimension in mm/inches



# Notice

#### Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment <sup>(Note 1)</sup>, transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications
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JÁPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII
CLASSⅣ	CLASSII	CLASSⅢ	CLASSI

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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  - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
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  - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

#### **Precaution for Product Label**

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

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When disposing Products please dispose them properly using an authorized industry waste company.

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# US6J11 - Web Page

**Distribution Inventory** 

Part Number	US6J11
Package	TUMT6
Unit Quantity	3000
Minimum Package Quantity	3000
Packing Type	Taping
Constitution Materials List	inquiry
RoHS	Yes